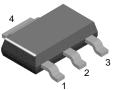


SEMICONDUCTOR

# **BCP51**

# **PNP General Purpose Amplifier**

- This device is designed for general purpose medium power amplifiers and switches requiring collecor currents to 1.0A.
- Sourced from process 77.



SOT-223

BCP51

1. Base 2. Collector 3. Emitter

# Absolute Maximum Ratings\* T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units	
CEO	Collector-Emitter Voltage	-45	V	
Сво	Collector-Base Voltage	-45	V	
ЕВО	Emitter-Base Voltage	-5.0	V	
0	Collector Current - Continuous	-1.5	А	
, T <sub>STG</sub>	Operating and Storage Junction Temperature Range	- 55 ~ 150	°C	

NOTES:

These ratings are based on a maximum junction temperature of 150 degrees C.
These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

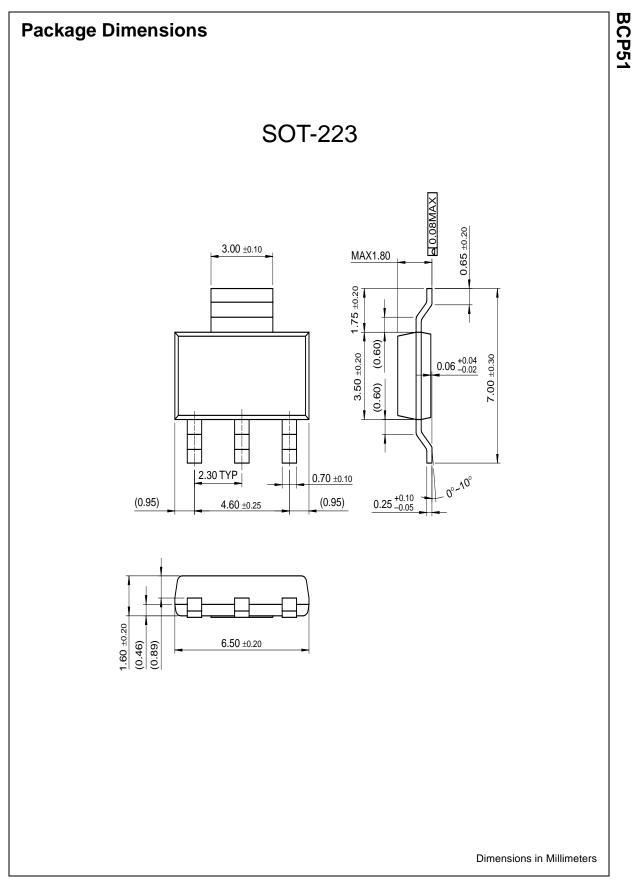
## Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Characte	eristics	-			
V <sub>(BR)CEO</sub>	Collector-Emitter Sustaining Voltage	$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = 0$	-45		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_{\rm C} = -100\mu A, I_{\rm E} = 0$	-45		V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_{E} = -10\mu A, I_{C} = 0$	-5.0		V
I <sub>CBO</sub>	Collector Cutoff Current	$V_{CB} = -30V, I_E = 0$ $V_{CB} = -30V, I_E = 0, T_a = 125^{\circ}C$		-100 -10	nA μA
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = -5.0V, I_{C} = 0$		-10	μΑ
On Characte	eristics				
h <sub>FE</sub>	DC Current Gain	$I_{C}$ = -5.0mA, $V_{CE}$ = -2.0V $I_{C}$ = -150mA, $V_{CE}$ = -2.0 $I_{C}$ = -500mA, $V_{CE}$ = -2.0V	25 40 25	250	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA		-0.5	V
V <sub>BE</sub> (on)	Base-Emitter On Voltage	I <sub>C</sub> = -500mA, V <sub>CE</sub> = -2.0V		-1.0	V

# Thermal Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation	1.0	W
	Derate above 25°C	8.0	mW/°C
R <sub>θJA</sub>	Thermal Resistance, Junction to Ambient	125	°C/W

Device mounted on FR-4PCB 36mm x 18mm x 1.5mm; mounting pad for the collector lead min. 6cm<sup>2</sup>.



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E <sup>2</sup> CMOS™	I <sup>2</sup> C™	MSXPro™	RapidConfigure™	TruTranslation™
EnSigna™	<i>i-</i> Lo™	OCX™	RapidConnect™	UHC™
FACT™	ImpliedDisconnect™	OCXPro™	µSerDes™	UltraFET <sup>®</sup>
FACT Quiet Series <sup>™</sup>	М	OPTOLOGIC®	SILENT SWITCHER <sup>®</sup>	VCX™
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Programmable Activ		POP™	Stealth™	

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